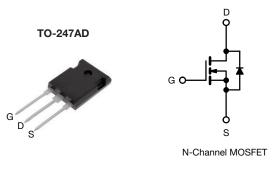
# SiHW21N80AE

**Vishay Siliconix** 



# **E Series Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V 0.205			
Q <sub>g</sub> max. (nC)	72			
Q <sub>gs</sub> (nC)	9			
Q <sub>gd</sub> (nC)	22			
Configuration	Single			

## FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-247AD
Lead (Pb)-free and halogen-free	SiHW21N80AE-GE3

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	800	v
Gate-source voltage		V <sub>GS</sub>	± 30	v
Continuous drain surront $(T = 150 ^{\circ}\text{C})$	at 10 V $\frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	- I <sub>D</sub>	17.4	
Continuous drain current ( $T_J = 150$ °C) $V_{GS}$ a	$T_{\rm C} = 100 ^{\circ}{\rm C}$		11	А
Pulsed drain current <sup>a</sup>		I <sub>DM</sub>	38	
Linear derating factor			1.4	W/°C
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	127	mJ
Maximum power dissipation		PD	179	W
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	70	1//
Reverse diode dv/dt <sup>d</sup>			39	V/ns
Soldering recommendations (peak temperature) c	For 10 s		260	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega,\,I_{AS}$  = 1.5 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25 °C





THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-		40			°0.00	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		0.7			°C/W	
		•						
<b>SPECIFICATIONS</b> ( $T_J = 25 \ ^{\circ}C$ ,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static						-		
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	800	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	2.0	-	4.0	V
	I	$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	, v	V <sub>GS</sub> = ± 30	V	-	-	± 1	μA
Zava acta valtaga duain avuvant	I	V <sub>DS</sub> =	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 640 V	, V <sub>GS</sub> = 0 V	′, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	١	<sub>D</sub> = 11 A	-	0.205	0.235	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 30 V, I <sub>D</sub>	= 3 A	-	4.0	-	S
Dynamic	-					•	•	•
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$		-	1388	-	
Output capacitance	C <sub>oss</sub>	, ,	$V_{\rm DS} = 100^{\circ}$	, V,	-	53	-	
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz	:	-	5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>		(1. 400.)/	N 0.V	-	43	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	- V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	276	-		
Total gate charge	Qg				-	48	72	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 11	A, V <sub>DS</sub> = 640 V	-	9	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	22	-	
Turn-on delay time	t <sub>d(on)</sub>				-	21	42	
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	640 V, I <sub>D</sub>	= 11 A,	-	38	76	
Turn-off delay time	t <sub>d(off)</sub>	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 20 \Omega$		-	71	107	ns	
Fall time	t <sub>f</sub>				-	76	114	
Gate input resistance	Rg	f = 1	MHz, oper	n drain	0.2	0.55	1.1	Ω
Drain-Source Body Diode Characterist	ics							
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET sym showing the	bol		-	-	17.4	_
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction			-	-	38	A
Diode forward voltage	V <sub>SD</sub>	T,J = 25 °C	C, I <sub>S</sub> = 11 A	, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	-			-	400	800	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25$	$5 ^{\circ}\text{C}, I_{\text{F}} = I_{\text{S}}$	= 11 A,	-	5	10	μC
Reverse recovery current	I <sub>RRM</sub>	di/dt = 1	100 A/µs, Ñ	/ <sub>R</sub> = 25 V	-	20	-	A

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

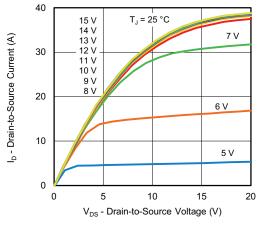


Fig. 1 - Typical Output Characteristics

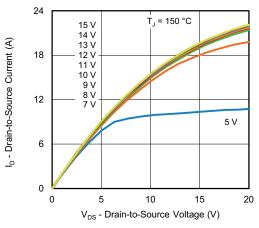


Fig. 2 - Typical Output Characteristics

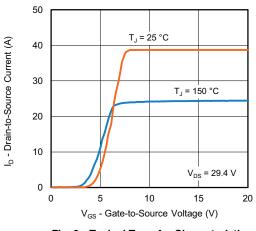


Fig. 3 - Typical Transfer Characteristics

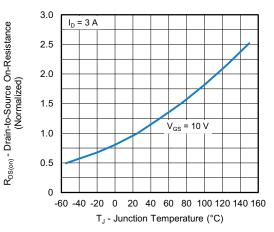


Fig. 4 - Normalized On-Resistance vs. Temperature

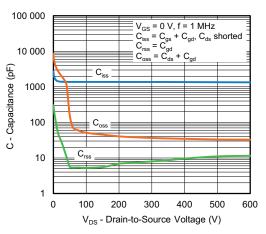
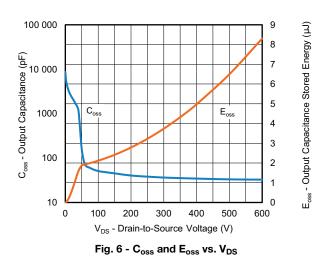


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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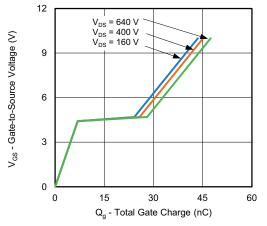


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

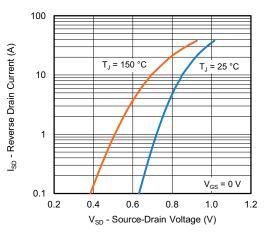


Fig. 8 - Typical Source-Drain Diode Forward Voltage

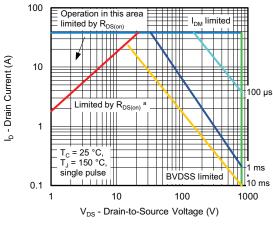


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

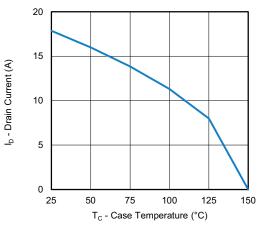


Fig. 10 - Maximum Drain Current vs. Case Temperature

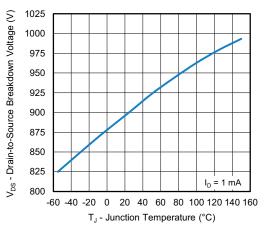


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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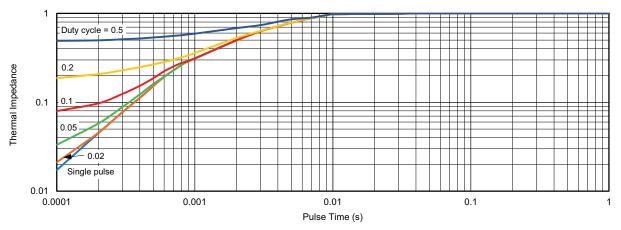
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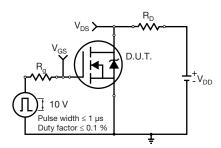


Fig. 13 - Switching Time Test Circuit

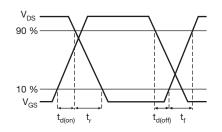


Fig. 14 - Switching Time Waveforms

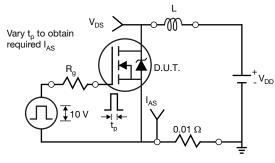


Fig. 15 - Unclamped Inductive Test Circuit

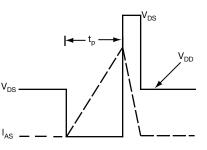


Fig. 16 - Unclamped Inductive Waveforms

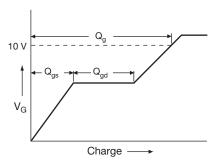


Fig. 17 - Basic Gate Charge Waveform

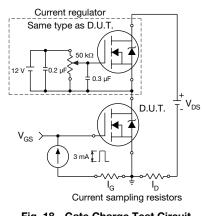


Fig. 18 - Gate Charge Test Circuit

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#### Peak Diode Recovery dv/dt Test Circuit

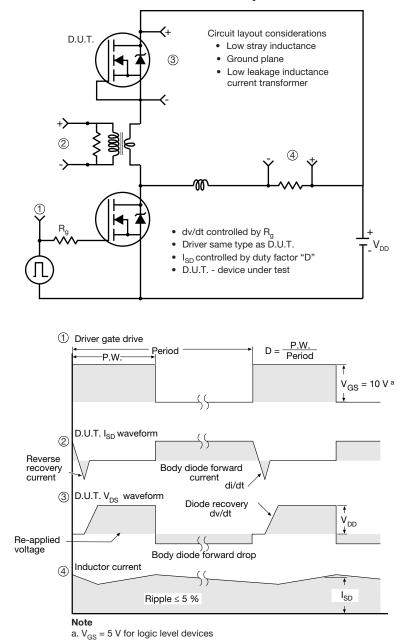


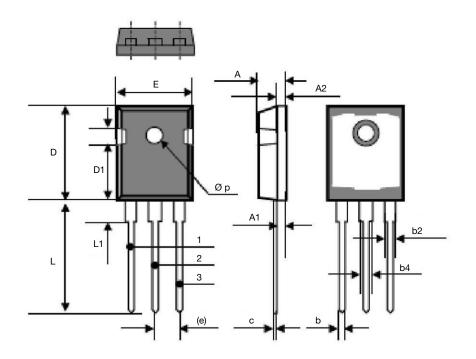
Fig. 19 - For N-Channel

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# TO-247AD (High Voltage)



DIM	MILLIN	<b>METERS</b>	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215	BSC	
E	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Øp	3.51	3.66	0.138	0.144	



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